

## Statement of Compliance

#### **Requested Part**

12 June 2023	<b>796964-1</b> (F		(Part 1 of 1)
TE Internal N	Number:	796964-1	
Product Des	cription:	PIN ASSY,18-16 AWG,HI CURREN	Т
Part	t Status:	Active	
Mil-Spec C	Certified:	No	
EU RoHS Directive 2011	/65/EU:	Compliant with Exemptions	
		6(c) - Pb-Alloy in Copper	

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions System Problem
China RoHS 2 Directive: MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JAN 2023 (233) SVHC > Threshold: Pb (2.5% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content:	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability Code:	Not applicable for solder process capability
Material Declarations:	MD_796964-1

**TE Connectivity Corporation** 

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

12 June 2023

**SI**)

### 中国电子电气产品中有害物质的名称及含量

#### China EEP Hazardous Substance Information

	有害物质							
ent Name)	Hazardous Substance							
796964-1	铅	汞	镉	六价铬	多溴联苯	多溴二苯酚		
	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)		
器系统	Х	0	0	0	0	0		
or Systems)								
				. a nomogon				
elow the relevant	threshold of th	e GB/T 26572	standard.					
示该有害物质至少	少在该部件的某	一均质材料中	的含量超出GE	3/T 26572标准	规定的限量要求	ڋ <sub>°</sub>		
	oncentration o	f the hazardou	is substance ir	at least one l	amaganaalis			
art is above the re					lomoyeneous	material of the		
	器系统 or Systems) 格依据SJ/T 1136 示该有害物质在证 dicates that the c elow the relevant	(Pb) 器系统 X or Systems) 格依据SJ/T 11364标准的规定编 示该有害物质在该部件所有均质 dicates that the concentration o elow the relevant threshold of th	(Pb) (Hg)   器系统 X O   or Systems) A O   格依据SJ/T 11364标准的规定编制。   示该有害物质在该部件所有均质材料中的含量   dicates that the concentration of the hazardou   elow the relevant threshold of the GB/T 26572	(Pb) (Hg) (Cd)   器系统 X O O   or Systems)   This table is   格依据SJ/T 11364标准的规定编制。 This table is   示该有害物质在该部件所有均质材料中的含量均在GB/T 265   dicates that the concentration of the hazardous substance in show the relevant threshold of the GB/T 26572 standard.	(Pb)(Hg)(Cd)(Cr6)器系统XOOOor Systems)OO格依据SJ/T 11364标准的规定编制。This table is compiled acc示该有害物质在该部件所有均质材料中的含量均在GB/T 26572标准规定的dicates that the concentration of the hazardous substance in all homogene elow the relevant threshold of the GB/T 26572 standard.	(Pb)(Hg)(Cd)(Cr6)(PBB)器系统XOOOOor Systems) </td		

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